



Specification of Automotive MLCC

(Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL21B682KC6WPNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 6.8 nF, 100V, ±10%, X7R, 0805

• AEC-Q 200 Specified

A. Samsung Part Number

<u>CL</u>	<u>21</u>	<u>B</u>	<u>682</u>	<u>K</u>	<u>C</u>	<u>6</u>	W	<u>P</u>	N	<u>C</u>
①	2	3	4	(5)	6	7	8	9	10	11

1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0805 (inch code)	L: 2.0	0 ± 0.1 mm	W:	1.25 ± 0.1	mm
3	Dielectric	X7R	8	Inner electrode	Ni	, Open mode	e
4	Capacitance	6.8 nF		Termination	Sc	oft Terminatio	n
(5)	Capacitance	±10 %		Plating	Sr	า 100%	(Pb Free)
	tolerance		9	Product	Αι	utomotive	
6	Rated Voltage	100 V	10	Grade code	St	andard	
7	Thickness	0.6 ± 0.1 mm	11)	Packaging	Ca	ardboard Typ	e, 7" reel

B. Reliability Test and Judgement condition

	Performance	Test condition			
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1000hrs@T=150 ℃			
Exposure	Capacitance Change : Within ±10%	Measurement at 24±2hrs after test conclusion			
	Tan δ : 0.03 max				
	IR : More than 10,000⋒Ω or 500⋒Ω× <i>μ</i> F				
	Whichever is Smaller				
Temperature Cycling	Appearance : No abnormal exterior appearance	1000Cycles			
	Capacitance Change : Within ±10%	Measurement at 24±2hrs after test conclusion			
	Tan δ : 0.03 max	1 cycle condition :			
	IR : More than 10,000MΩ or 500MΩ×μF	-55+0/-3℃(15±3min) -> Room Temp(1min.)			
	Whichever is Smaller	-> 125+3/-0 ℃ (15±3min) -> Room Temp(1min.)			
Destructive Physical No Defects or abnormalities F		Per EIA 469			
Analysis					
Moisture Resistance Appearance : No abnormal exterior appearance		10Cycles, t=24hrs/cycle			
	Capacitance Change : Within ±12.5%	Heat (25~65℃) and humidity (80~98%), Unpowered			
	Tan δ : 0.03 max	measurement at 24±2hrs after test conclusion			
	IR : More than 10,000№ or 500№×μF				
	Whichever is Smaller				
Humidity Bias	Appearance : No abnormal exterior appearance	1000hrs 85℃/85%RH, Rated Voltate and 1.3~1.5V,			
	Capacitance Change : Within ±12.5%	Add 100kohm resistor			
	Tan δ : 0.035 max	Measurement at 24±2hrs after test conclusion			
	IR : More than 500MΩ or 25MΩ×μF	The charge/discharge current is less than 50mA.			
	Whichever is Smaller				
High Temperature Appearance : No abnormal exterior appearance		1000hrs @ TA=125℃, 200% Rated Voltage,			
Operating Life	Capacitance Change : Within ±12.5%	Measurement at 24±2hrs after test conclusion			
	Tan δ: 0.035 max	The charge/discharge current is less than 50mA.			
	IR : More than 1000№ or 50№×μF				
	Whichever is Smaller				

	Performance	Test condition				
External Visual	No abnormal exterior appearance	Microscope ('10)				
Physical Dimensions	Within the specified dimensions	Using The calipers				
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along				
	Capacitance Change : Within ±10%	3 mutually perpendicular axes of the test specimen (18 shocks)				
	Tan δ, IR : initial spec.	Peakvalue Duration Wave Velocity				
		1,500G 0.5ms Half sine 4.7m/sec.				
N	No observation to design					
Vibration						
	Capacitance Change: Within ±10%	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted				
	Tan δ, IR : initial spec.	within 2" from any secure point. Test from 10~2000Hz.				
Resistance to	Appearance : No abnormal exterior appearance	Solder pot : 260±5°C, 10±1sec.				
Solder Heat	Capacitance Change: Within ±10%	Oblider pot 1. 20013 0, 1011366.				
Colder fieut	Tan δ, IR: initial spec.					
	Turi o, ir c. iiiliai opoo.					
Thermal Shock	Appearance : No abnormal exterior appearance	-55℃/+125℃.				
	Capacitance Change : Within ±10%	Note: Number of cycles required-300,				
	Tan δ, IR : initial spec.	Maximum transfer time-20 sec, Dwell time-15min. Air-Air				
	·					
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002				
	Capacitance Change : Within ±10%					
	Tan δ, IR : initial spec.					
Solderability	95% of the terminations is to be soldered	a) Preheat at 155 °C for 4 hours, Immerse in solder for 5s at 245±5 °C				
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5℃				
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5 °C				
		solder : a solution ethanol and rosin				
Electrical	Capacitance : Within specified tolerance	The Capacitance /D.F. should be measured at 25 ℃,				
Characterization	Tan δ (DF): 0.025 max.	1tl±±10%, 1.0±0.2Vrms				
	IR(25 ℃): More than 10,000MΩ or 500MΩ×μF	I.R. should be measured with a DC voltage not exceeding				
	IR(125℃): More than1,000MΩ or 10MΩ×μF	Rated Voltage @25℃, @125℃ for 60~120 sec.				
	Whichever is Smaller Dielectric Strength	Dielectric Strength :200% of the rated voltage for 1~5 seconds				
Board Flex	-	Bending to the limit (2mm) for 5 seconds				
Doura i lox	Capacitance Change: Within ±10%	bending to the mine (2mm) for a seconds				
	Capacitance change : Wallin 17070					
Terminal	Appearance : No abnormal exterior appearance	18N, for 60±1 sec.				
Strength(SMD)	Capacitance Change : Within ±10%					
Beam Load	Destruction value should not be exceed	Beam speed				
	Chip Length < 2.5mm	0.5±0.05mm/sec				
	a) Chip Thickness > 0.5mm : 20N					
	b) Chip Thickness ≤ 0.5mm : 8N					
Temperature	X7R					
Characterisitcs	(From -55℃ to 125℃, Capacitance change shou	uld be within ±15%)				

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}\!\!\mathrm{C}$, 10sec. Max)

Meet IPC/JEDEC J-STD-020 D Standard



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.